



P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI

Product Summary

BV _{DSS}	Rds(on)	I _D Tc = +25°C
-30V	28mΩ @ V _{GS} = -10V	-21A
-307	38mΩ @ V _{GS} = -4.5V	-18A

Features

- Low R_{DS(ON)} Minimizes On-State Losses
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- 100% Unclamped Inductive Switching Ensures More Reliability
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Description and Applications

This new generation MOSFET is designed to minimize R_{DS(ON)} yet maintain superior switching performance. This device is ideal for use in power management and load switch.

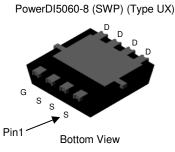
- Backlighting
- Power Management Functions
- DC-DC Converters

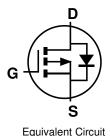
Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ³
- Weight: 0.097 grams (Approximate)



Top View





Ordering Information (Note 4)

Part Number	Case	Packaging
DMP3028LPSW-13	PowerDI5060-8 (SWP) (Type UX)	2,500 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



);; = Manufacturer's Marking
P3028LPW = Product Type Marking Code
\(\overline{\text{YY}}\) WW = Date Code Marking
\(\overline{\text{YY}}\) = Year (ex: 21 = 2021)
\(\overline{\text{WW}}\) = Week (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@T_C = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	-30	V
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 6)	ΙD	-21 -17	А		
Maximum Continuous Body Diode Forward Current (Not	ls	-20	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			lом	-70	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			lsм	-70	Α
Avalanche Current, L = 0.1mH			las	-22	Α
Avalanche Energy, L = 0.1mH			Eas	24	mJ

Thermal Characteristics (@T_C = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	PD	1.28	W
Thermal Resistance, Junction to Ambient (Note 5)		$R_{\theta JA}$	100	°C/W
Total Power Dissipation (Note 6)	$T_C = +25^{\circ}C$	PD	2.1	W
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	60	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@Tc = +25°C, unless otherwise specified.)

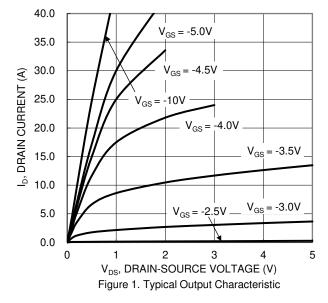
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30			V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μΑ	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	-1.0	-1.3	-2.4	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
Static Drain-Source On-Resistance	D		18	28	mΩ	$V_{GS} = -10V, I_{D} = -7A$	
Static Drain-Source On-nesistance	Rds(on)	_	28	38	11122	$V_{GS} = -4.5V$, $I_{D} = -6.2A$	
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -2.1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	1	1421			V _{DS} = -15V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss		147	_	pF		
Reverse Transfer Capacitance	Crss	_	110	_			
Gate Resistance	Rg	_	15	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = -10V)	Qg	_	22	_		V _{DS} = -15V, I _D = -7A	
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	11	_	~C		
Gate-Source Charge	Qgs	_	3.5	_	nC		
Gate-Drain Charge	Qgd	_	4.7	_			
Turn-On Delay Time	tD(ON)		9.7	_		$V_{DD} = -15V, V_{GS} = -10V,$ $I_{D} = -7A, R_{G} = 6\Omega$	
Turn-On Rise Time	t _R	_	17.1	_			
Turn-Off Delay Time	tD(OFF)		60.5	_	ns		
Turn-Off Fall Time	tr		40.4	_			
Body Diode Reverse Recovery Time	t _{RR}		10.3	_	ns	1 7A 41/44 400A/44	
Body Diode Reverse Recovery Charge	Qrr	-	3.1	_	nC	Is = -7A, di/dt = 100A/μs	

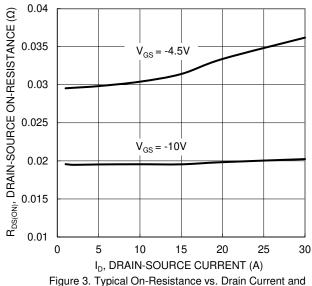
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

^{6.} Thermal resistance from junction to soldering point (on the exposed drain pad).

^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to production testing.







Gate Voltage

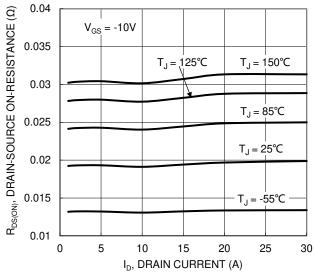
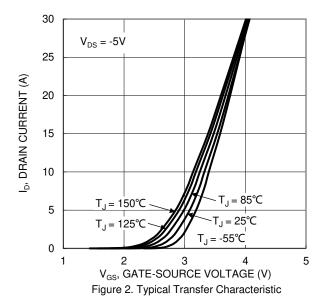
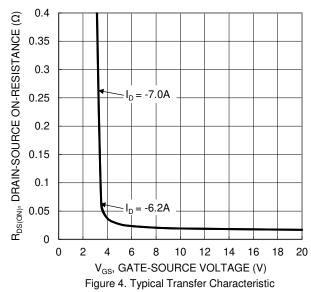


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





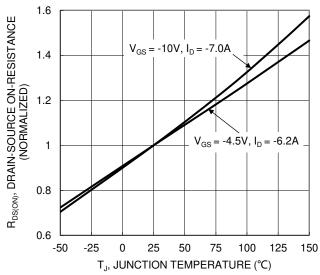


Figure 6. On-Resistance Variation with Junction Temperature



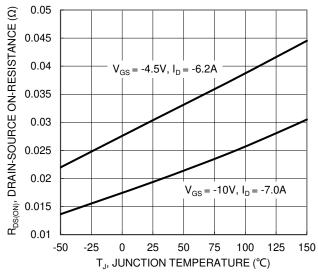
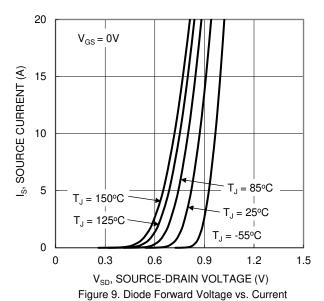


Figure 7. On-Resistance Variation with Junction Temperature



10 8 6 $V_{GS}(V)$ 4 $V_{DS} = -15V, I_{D} = -7.5A$ 2 0 0 5 10 15 20 25 30 Q_g (nC)

Figure 11. Gate Charge

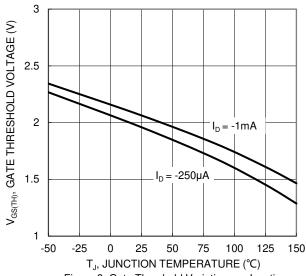
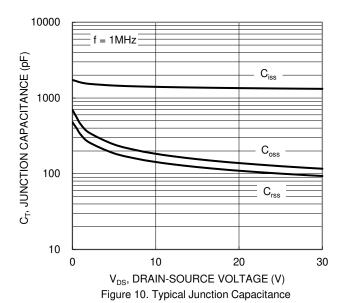


Figure 8. Gate Threshold Variation vs. Junction Temperature

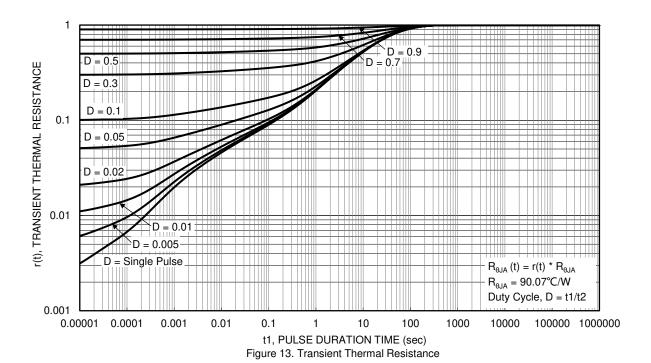


1000 $\begin{array}{c} R_{\text{DS(ON)}} \\ \text{Limited} \end{array}$ $= 10 \mu s$ 100 ID, DRAIN CURRENT (A) 10 = 10 msT_{J(Max)} = 150°C w = 100ms $T_{\rm C} = 25\,^{\circ}{\rm C}$ $P_W = 1s$ Single Pulse DUT on Infinite 0.1 Heatsink $V_{GS} = -10V$ 0.01 0.1 10 100

 V_{DS} , DRAIN-SOURCE VOLTAGE (V)

Figure 12. SOA, Safe Operation Area







Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type UX) 1.900 D1 O1.000 Depth 0.07±0.030 DE TAIL A DE TAIL A

DewarDIE060 9 (CWD)						
PowerDI5060-8 (SWP) (Type UX)						
Dim	Min	Тур				
Α	0.90	1.10	1.00			
A1	0	0.05				
b	0.30	0.50	0.41			
b2	0.20	0.35	0.25			
b4).25REF	•			
С	0.230	0.330	0.277			
D	5	.15 BS()			
D1	4.70	5.10	4.90			
D2	3.56	3.96	3.76			
D2a	3.78 4.18		3.98			
Е	_	.40 BS0				
E1	5.60	6.00	5.80			
E2	3.46	3.86	3.66			
E2a	4.195	4.595	4.395			
е		.27BSC)			
k	1.05					
L	0.635	0.835	0.735			
La	0.635	0.835	0.735			
L1	0.200	0.400	0.300			
L1a	0.050REF					
L4	0.025	0.225	0.125			
М	3.205	4.005	3.605			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All	All Dimensions in mm					

Seating Plane

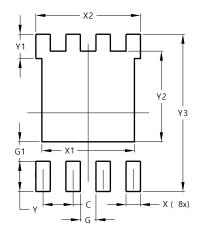
DETAIL A

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

b4(8x)

PowerDI5060-8 (SWP) (Type UX)



Dimensions	Value		
	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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